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FORM PTO-1595

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OMB No. 0651-0011 (exp. 4/94)

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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Hideki Sano
509-3, A-102, Hokkubara,
Gotenba-shi, Shizuoka, Japan

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)

Name: Texas Instruments Incorporated

Internal Address: _____

Street Address: 7839 Churchill Way

MS 3999

City: Dallas State: TX ZIP: 75251

Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other _____

Execution Date: 12/19/00, 12/21/00

4. Application number(s) or patent number(s):

9/753479

If this document is being filed together with a new application, the execution date of the application is: 12/19/00

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Russell E. Baumann

Internal Address: _____

Texas Instruments Incorporated

Street Address: 34 Forest Street

MS 20-21

City: Attleboro State: MA ZIP: 02703

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41).....\$ 40.00

Enclosed

Authorized to be charged to deposit account

8. Deposit account number:

20-0670

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Russell E. Baumann

Name of Person Signing

Russell E. Baumann
Signature

1/3/01

Date

Total number of pages including cover sheet, attachments, and document:

4

Mail documents to be recorded with required cover sheet information to:

Commissioner of Patents & Trademarks, Box Assignments

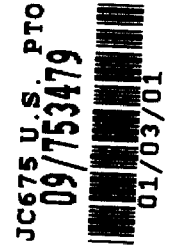
PATENT

Washington, D.C. 20231

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U.S. Department of Commerce
Patent and Trademark Office

Recordation Form Cover Sheet
Patents Only



Additional name(s) & address(es) - continued:

2. Kiyokazu Ikeya
187 Ueno, Oyama-cho, Sunto-gun,
Shizuoka, Japan

3. Texas Instruments Japan Ltd.
Aoyama Fuji Bldg. 4/F
6-12, Kita-Aoyama 3-Chome
Minato-Ku, Tokyo
Japan 107-8641

ASSIGNMENT

WHEREAS, TEXAS INSTRUMENTS JAPAN LTD. (hereinafter TI-JAPAN), a Japanese company of Oyama, Japan, has under the laws of Japan made application, in its own name, for Letters Patent in Japan in respect of an invention as set forth below;

WHEREAS, the or each below named inventor (hereinafter INVENTOR) is the or an inventor of the said invention;

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 7839 Churchill Way, MS 3999, Dallas, Texas 75251, is desirous of acquiring our entire right, title and interest in and to the said invention outside of Japan, and in and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, TI-JAPAN and INVENTOR(S) sell and assign to the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, the entire right, title and interest in and to the said invention in the U.S.A. and all other countries outside Japan; in and to the U.S. patent application executed as identified below and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and to file applications and obtain patents in its own name in any said other country or group of countries, and to claim priority under the terms of the International Convention for the Protection of Industrial Property or any other relevant convention;

TI-JAPAN and INVENTOR hereby authorize and request the Commissioner of Patents to issue U.S. patents for said invention, or U.S. patents resulting therefrom, insofar as our interest is concerned to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of the entire right, title and interest.

TI-JAPAN and INVENTOR further agree to communicate to TEXAS INSTRUMENTS INCORPORATED or to its successors, assigns, and legal representatives, any facts known to them respecting the said invention, and at the expense of TEXAS INSTRUMENTS INCORPORATED, sign any and all patent applications, assignments, affidavits, and other lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, testify in any legal or quasi-legal proceedings and generally everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries outside Japan.

Title of Invention: SOCKET APPARATUS FOR IC PACKAGES

Inventor(s): Hideki Sano, Kiyokazu Ikeya

Application No.: 2000-20253

Filed: January 28, 2000

U.S. Application Executed on: _____


IN WITNESS WHEREOF, this agreement has been executed as set forth below:

Signed at: Oyama, Japan

On: December 21, 2000

by Texas Instruments Japan Ltd.

Name: Toshiaki Ikoma

Signature: 

Title: Representative Director

Date: Dec. 21, 2000

and by the INVENTOR(S):

Name: Hideki Sano

Signature: 

Date: Dec. 19, 2000

Address: 509-3, A-102, Hokkubara, Gotenba-shi, Shizuoka, Japan

Name: Kiyokazu Ikeya

Signature: 

Date: Dec. 19, 2000

Address: 187 Ueno, Oyama-cho, Suntoh-gun, Shizuoka, Japan

Name: _____

Signature: _____

Date: _____

Address: _____